

DWG. NO. SD-53398-034

F

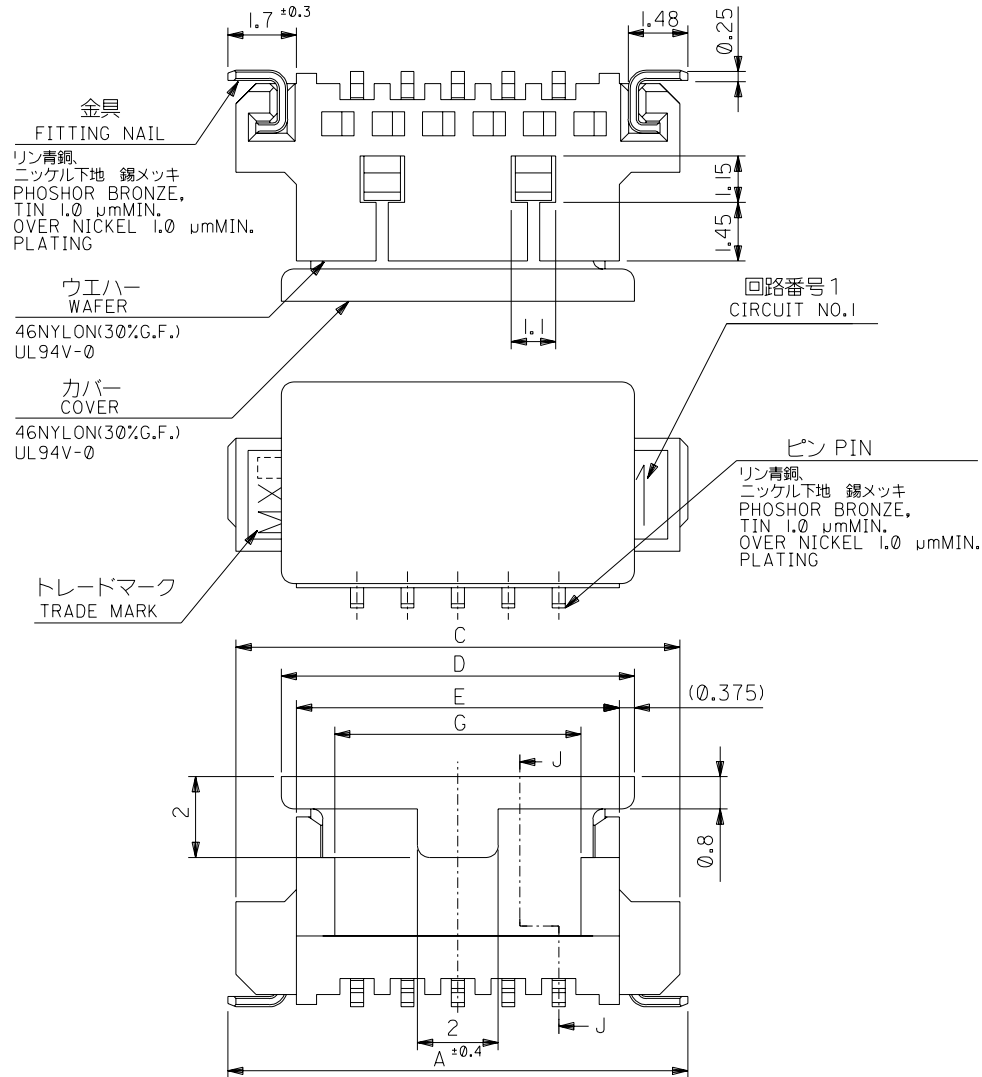
E

D

C

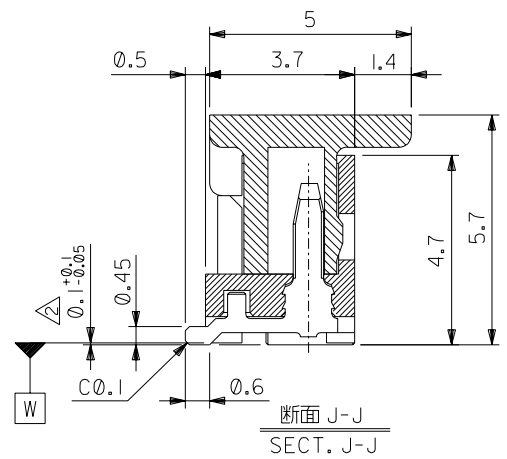
B

DO NOT SCALE DRAWING



NOTES

1. 嵌合相手: 51021 シリーズ MATE WITH : 51021 SERIES
2. 水平面上において、ウェハー底面 **W** とソルダーテール及びフィッティングネイル底面とのズレ量を示す。  
MISALIGNMENT OF SOLDER TAIL & FITTING NAIL FROM **W**
3. 偶数極にのみ適用。APPLY EVEN CIRCUIT PRODUCTS.
4. 本製品は 53398-\*\*-20 の鉛フリー品である。  
THIS PRODUCT IS LEAD FREE OF 53398-\*\*-20.

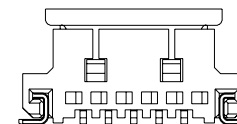


17.35	18.05	19.25	20	22.25	16.25	22.3	53398-1429	14
14.85	15.55	16.75	17.5	19.75	13.75	20.15	53398-1229	12
9.85	10.55	11.75	12.5	14.75	8.75	15.15	53398-0829	8
8.6	9.3	10.5	11.25	13.5	7.5	13.9	53398-0729	7
7.35	8.05	9.25	10	12.25	6.25	12.65	53398-0629	6
6.1	6.8	8	8.75	11	5	11.4	53398-0529	5
4.85	5.55	6.75	7.5	9.75	3.75	10.15	53398-0429	4
3.6	4.3	5.5	6.25	8.5	2.5	8.9	53398-0329	3
2.35	3.05	4.25	5	7.25	1.25	7.65	53398-0229	2
G	F	E	D	C	B	A	MATERIAL NO.	CIRCUITS

EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	RELEASED '04/02/12 EC NO. J2004-2404 DRWN: Y.SAKIYAMA CHK: M.SASAO APPR: M.SASAO	MATERIAL 材料  SEE DRAWING	GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差	SCALE —	MODEL NO. DESIGN UNITS 53398-**-29 THIRD ANGLE PROJECTION	DIMENSIONS: mm INCH mm INCH mm ONLY	SHT REV	
						FINISH 仕上げ —	10 UNDER 未満 ±0.2	DRAWN BY & DATE Y.SAKIYAMA '04/02/12	TITLE: 1.25 WIRE TO BOARD CONN. WAFER ASS'Y FOR SMT (ST.) WITH COVER -LEAD FREE-			
						WIRE RANGE 適用電線範囲 —	10 OVER 30 UNDER 以上 未満 ±0.25	CHECKED BY & DATE M.SASAO '04/02/12	MOLEX INCORPORATED			
						INS. RANGE 被覆外径 —	30 OVER 以上 ±0.3	APPROVED BY & DATE M.SASAO '04/02/12	MATERIAL NO. SD-53398-034.S01	DRAWING NO. SD-53398-034	SHEET NO. 1 OF 2	
								THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.			SIZE B	

A

SD-53398-034.S01



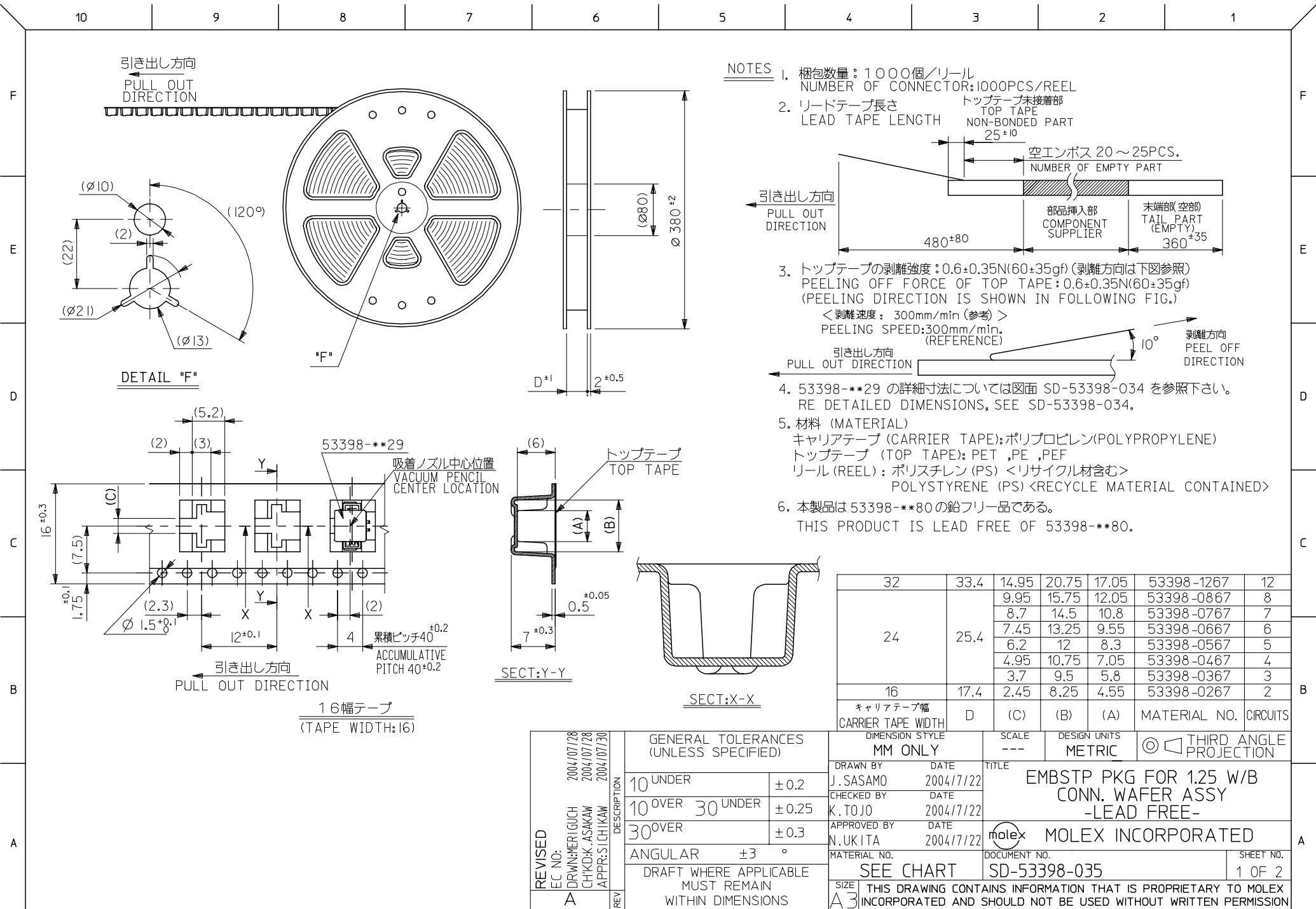
4極以上  
OVER 4 CKT.

△5 ロック形状図  
LOCK CONFIGURATION

NOTES

⑤ ロック窓は、2, 3極は1ヶ所、4極以上は2ヶ所とする。  
LOCKING WINDOW : ONE PLACE FOR 2&3 CKTS.  
TWO PLACES FOR MORE THAN 4 CKTS.

EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	EC NO. DRWN: CHK: APPR:	RELEASED '04/02/12 EC NO. J2004-2404 DRWN: Y.SAKIYAMA CHK: M.SASAO APPR: M.SASAO	DESCRIPTION	MATERIAL 材料  SEE NOTES	GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差	SCALE —//—	MODEL NO. DESIGN UNITS ☑mm ☐INCH	53398-**29 THIRD ANGLE PROJECTION ☉	DIMENSIONS: ☐mm INCH mm ☒mm ONLY	SHT REVISE ON CAD ONLY	REV
						FINISH 仕上げ —#—	10 UNDER 未満	±0.2	DRAWN BY & DATE Y.SAKIYAMA '04/02/12	TITLE: 1.25 WIRE TO BOARD CONN. WAFER ASS'Y FOR SMT (ST.) WITH COVER -LEAD FREE-			
							10 OVER 以上	±0.25	CHECKED BY & DATE M.SASAO '04/02/12				
							30 UNDER 未満	±0.25	APPROVED BY & DATE M.SASAO '04/02/12				
						WIRE RANGE 適用電線範囲 —#—	ANGLE 角度	±3°	CAD FILENAME SD-53398-034.S02	MATERIAL NO. SEE CHART	DRAWING NO. SD-53398-034	SHEET NO. 2 OF 2	SIZE B
					REV	INS. RANGE 被覆外径 —#—	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.						



10 9 8 7 6 5 4 3 2 1

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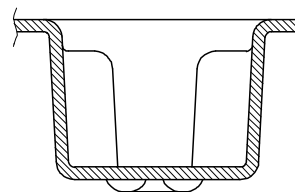
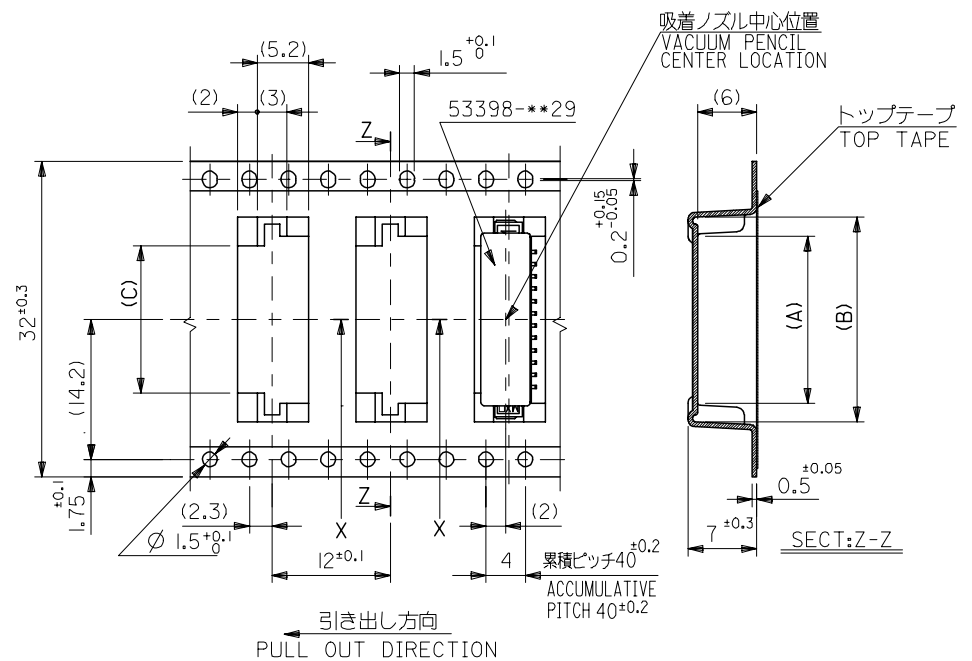
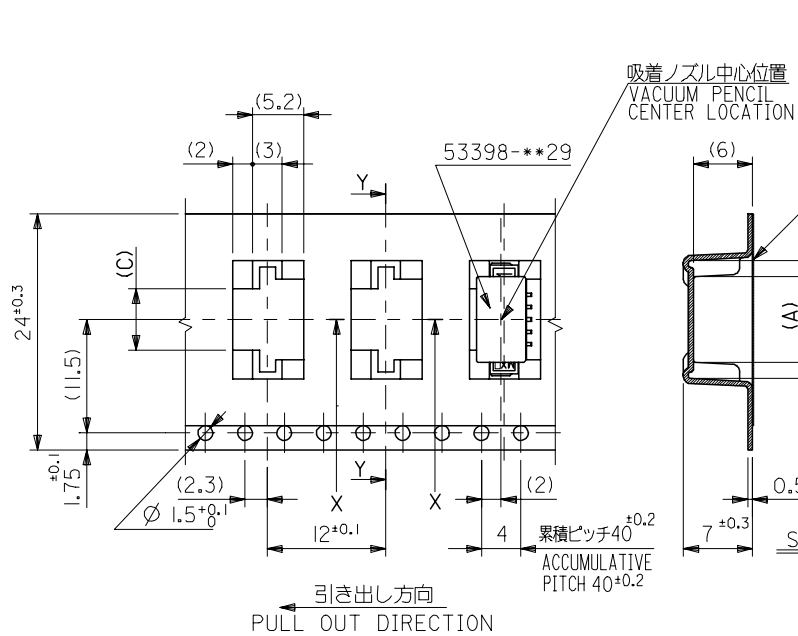
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B

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SECT:X-X

REVISED EC NO: DRAWN: M. ICHIKAWA CHKD: K. ASAKAWA APPR: S. ICHIKAWA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY J. SASAMO	DATE 2004/7/22	TITLE EMBSTP PKG FOR 1.25 W/B CONN. WAFER ASSY -LEAD FREE-				
		10 OVER 30 UNDER	±0.25	CHECKED BY K. TOJO	DATE 2004/7/22					
		30 OVER	±0.3	APPROVED BY N. UKITA	DATE 2004/7/22	MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-53398-035		2 OF 2		
A	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

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